

N and P Channel Enhancement Mode Power MOSFET

Description

This Product uses advanced trench technology MOSFETs to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

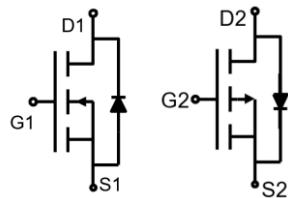
- NMOS
- V_{DS} 60V
- I_D (at $V_{GS} = 10V$) 5A
- $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 36mΩ
- $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 40mΩ

PMOS

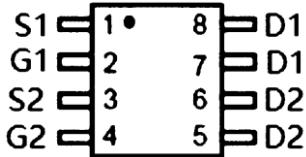
- V_{DS} -60V
- I_D (at $V_{GS} = -10V$) -3.1A
- $R_{DS(ON)}$ (at $V_{GS} = -10V$) < 80mΩ
- $R_{DS(ON)}$ (at $V_{GS} = -4.5V$) < 95mΩ
- RoHS Compliant

Application

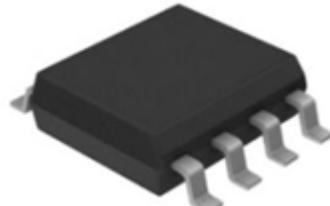
- Power switch
- DC/DC converters



Schematic diagram



Marking and pin assignment



SOP-8

| Device | Package | Marking | Packaging |
|-----------|---------|---------|--------------|
| G05NP06S2 | SOP-8双基 | G05NP06 | 4000pcs/Reel |

Absolute Maximum Ratings $T_C = 25^{\circ}\text{C}$, unless otherwise noted

| Parameter | Symbol | NMOS | PMOS | Unit |
|--|----------------|------------|------------|------|
| Drain-Source Voltage | V_{DS} | 60 | -60 | V |
| Continuous Drain Current | I_D | 5 | -3.1 | A |
| Pulsed Drain Current (note1) | I_{DM} | 20 | -12.4 | A |
| Gate-Source Voltage | V_{GS} | ± 20 | ± 20 | V |
| Power Dissipation | P_D | 2.5 | 1.9 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 To 150 | -55 To 150 | °C |

Thermal Resistance

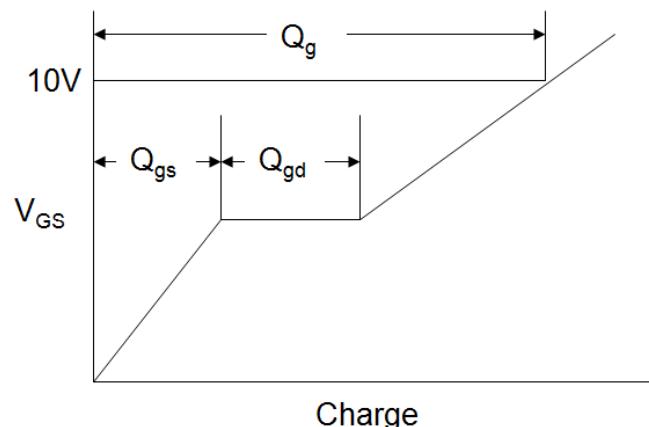
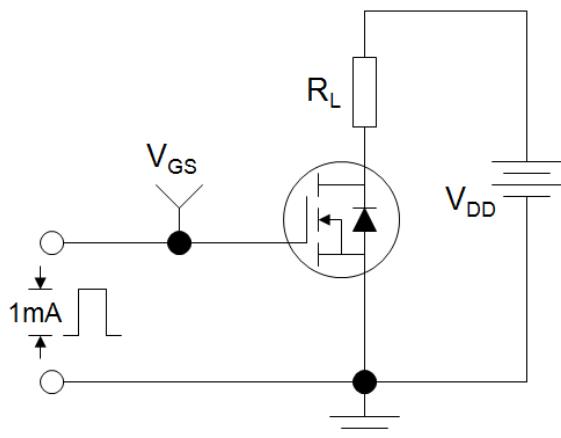
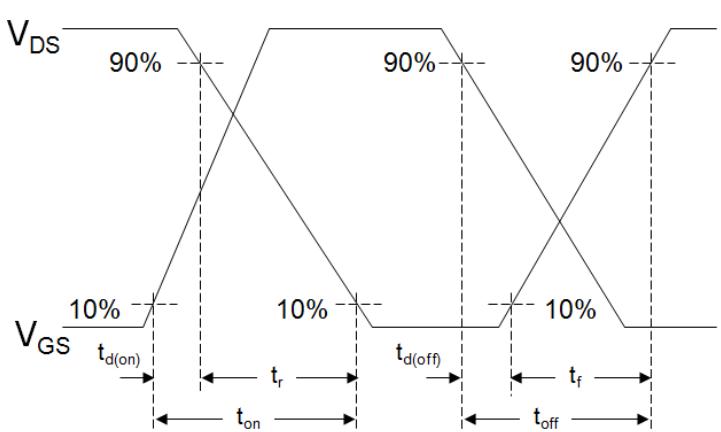
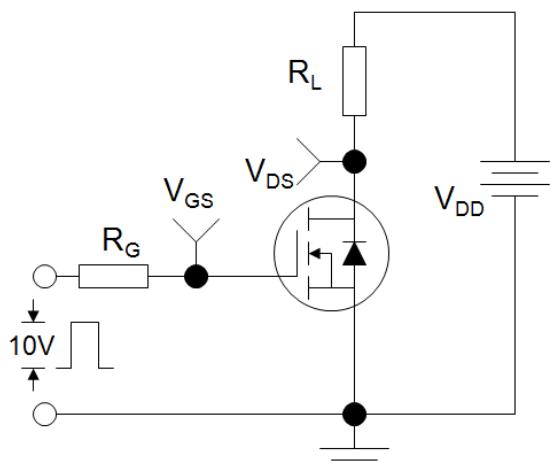
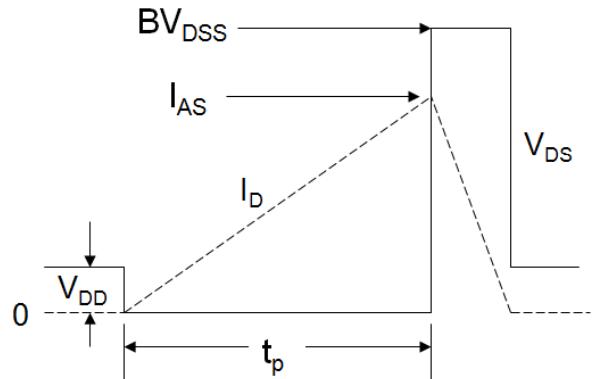
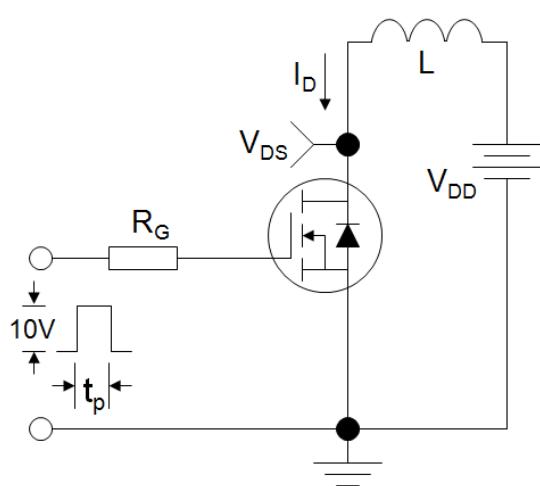
| Parameter | Symbol | NMOS | PMOS | Unit |
|---|------------|------|------|------|
| Thermal Resistance, Junction-to-Ambient | R_{thJA} | 50 | 65 | °C/W |

NMOS Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Test Conditions | Value | | | Unit |
|--|-----------------------------|--|-------|------|-----------|------------------|
| | | | Min. | Typ. | Max. | |
| Static Parameters | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 60 | -- | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 25^\circ\text{C}$ | -- | -- | 1 | μA |
| Gate-Source Leakage | I_{GSS} | $V_{\text{GS}} = \pm 20\text{V}$ | -- | -- | ± 100 | nA |
| Gate-Source Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 1.0 | 1.5 | 2.0 | V |
| Drain-Source On-Resistance | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 4.3\text{A}$ | -- | 28 | 36 | $\text{m}\Omega$ |
| | | $V_{\text{GS}} = 4.5\text{V}, I_D = 3.9\text{A}$ | -- | 31 | 40 | |
| Forward Transconductance | g_{FS} | $V_{\text{DS}}=5\text{V}, I_D=4.3\text{A}$ | -- | 9.6 | -- | S |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 30\text{V}, f = 1.0\text{MHz}$ | -- | 1336 | -- | pF |
| Output Capacitance | C_{oss} | | -- | 56 | -- | |
| Reverse Transfer Capacitance | C_{rss} | | -- | 52 | -- | |
| Total Gate Charge | Q_g | $V_{\text{DS}} = 30\text{V}, I_D = 5\text{A}, V_{\text{GS}} = 10\text{V}$ | -- | 22 | -- | nC |
| Gate-Source Charge | Q_{gs} | | -- | 3.3 | -- | |
| Gate-Drain Charge | Q_{gd} | | -- | 5.2 | -- | |
| Turn-on Delay Time | $t_{\text{d}(\text{on})}$ | $V_{\text{DD}} = 30\text{V}, I_D = 5\text{A}, R_G = 3\Omega$ | -- | 5.2 | -- | ns |
| Turn-on Rise Time | t_r | | -- | 3 | -- | |
| Turn-off Delay Time | $t_{\text{d}(\text{off})}$ | | -- | 17 | -- | |
| Turn-off Fall Time | t_f | | -- | 2.5 | -- | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Body Diode Voltage | V_{SD} | $T_J = 25^\circ\text{C}, I_{\text{SD}} = 1.7\text{A}, V_{\text{GS}} = 0\text{V}$ | -- | -- | 1.2 | V |
| Continuous Body Diode Current | I_s | $T_C = 25^\circ\text{C}$ | -- | -- | 5 | A |

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

Gate Charge Test Circuit**Switch Time Test Circuit****EAS Test Circuit**

NMOS Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

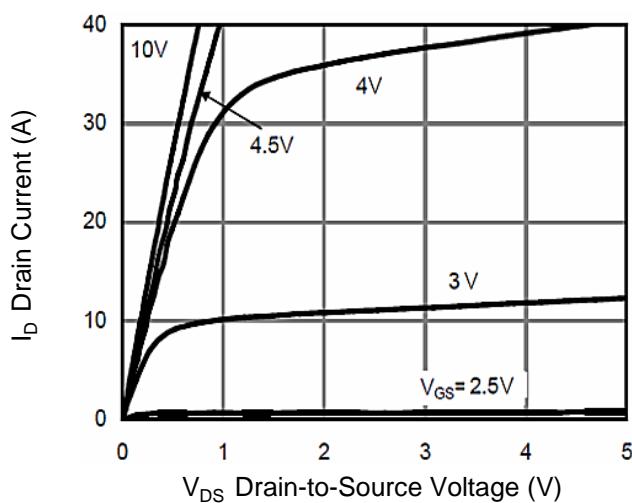


Figure 2. Transfer Characteristics

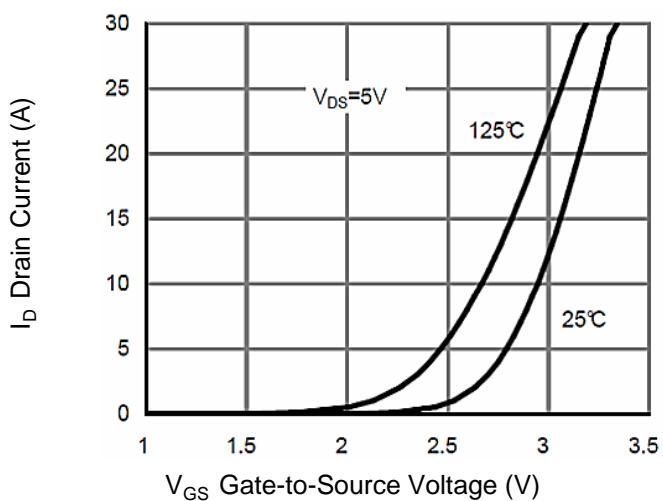


Figure 3. Drain-Source On-Resistance

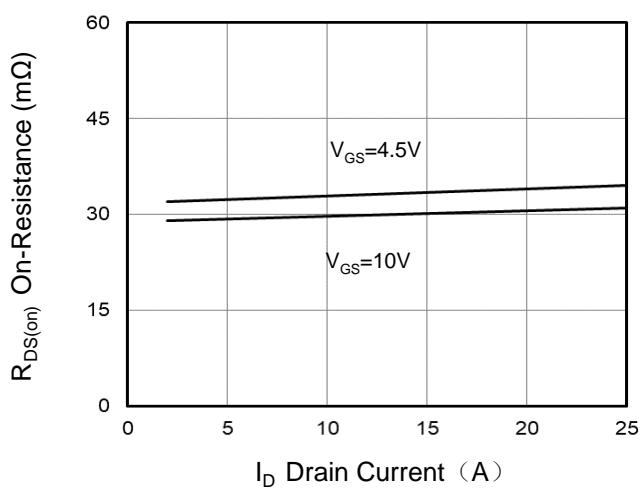


Figure 4. Gate Charge

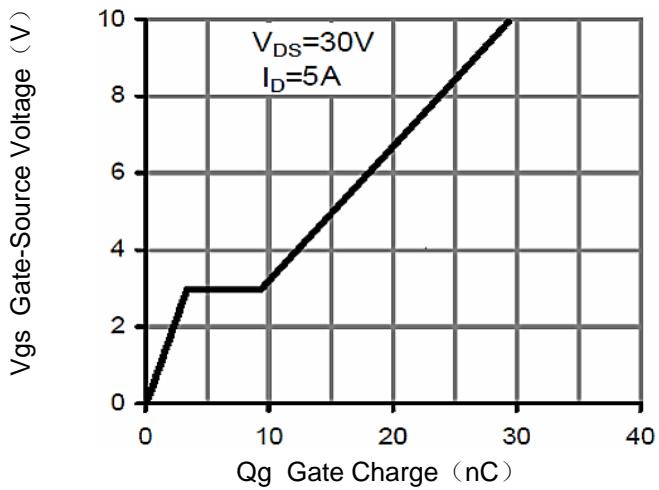


Figure 5. Capacitance

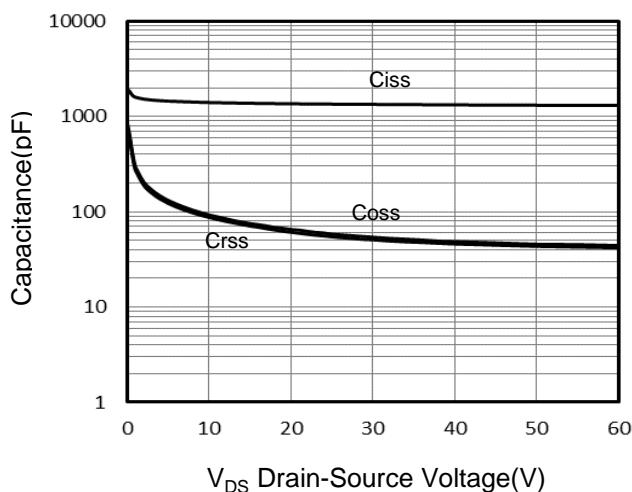
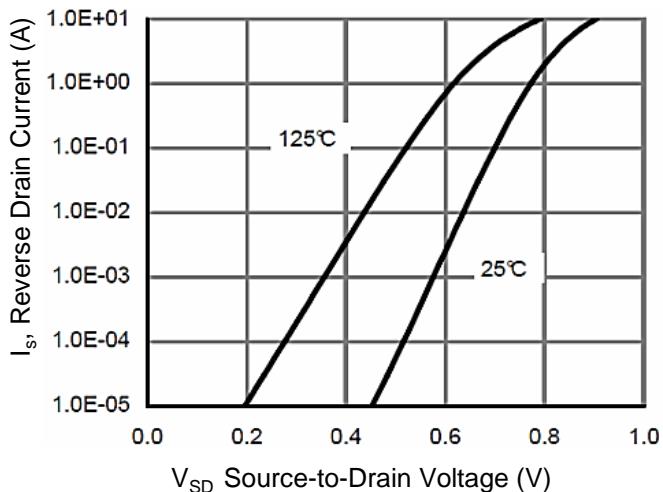


Figure 6. Source-Drain Diode Forward



NMOS Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

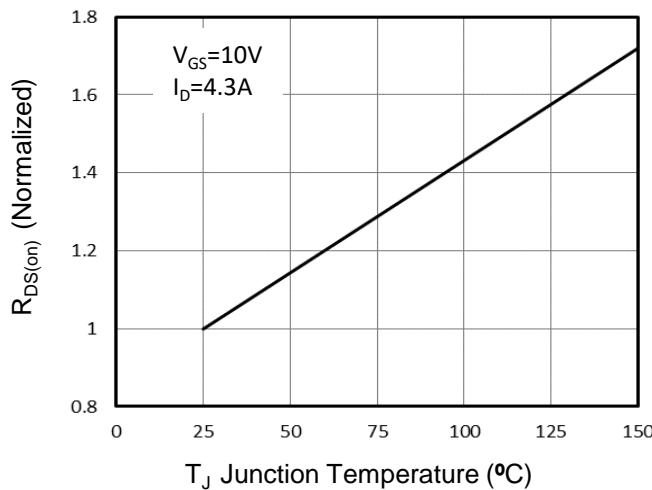


Figure 8. Safe Operation Area

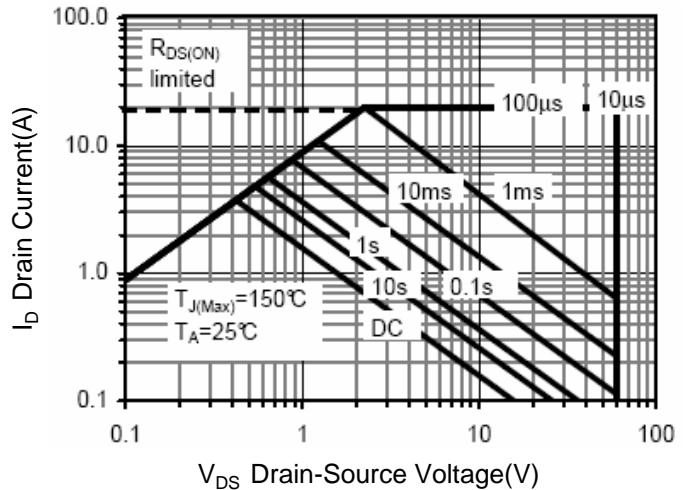
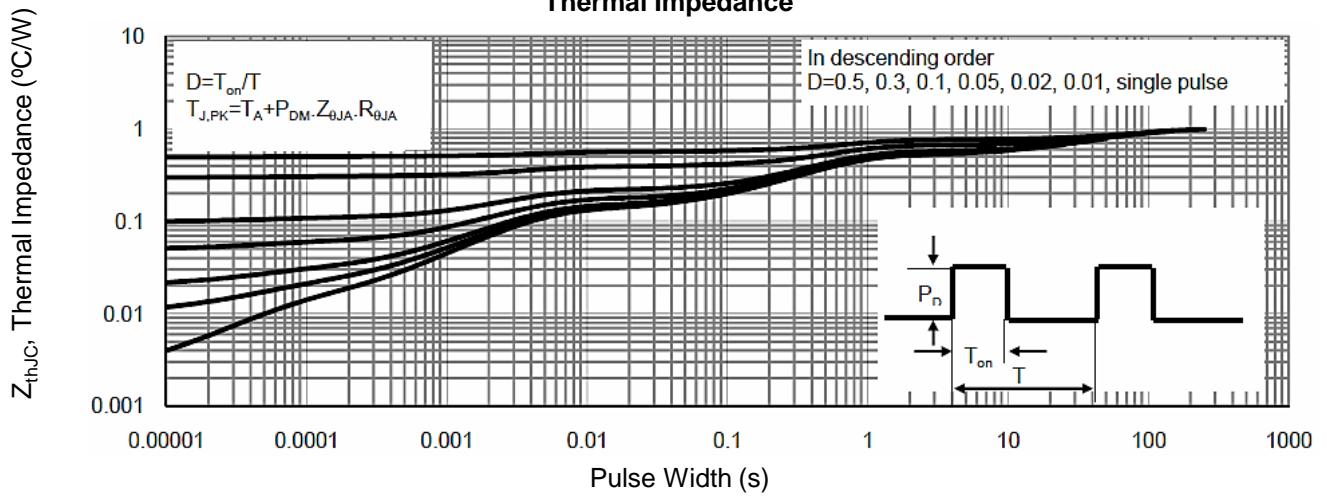


Figure 9. Normalized Maximum Transient Thermal Impedance



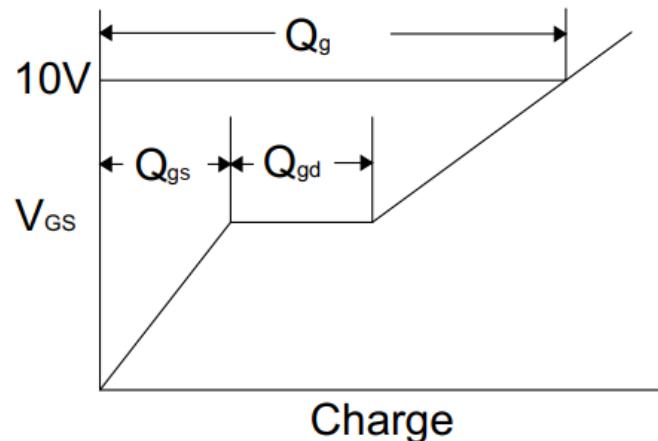
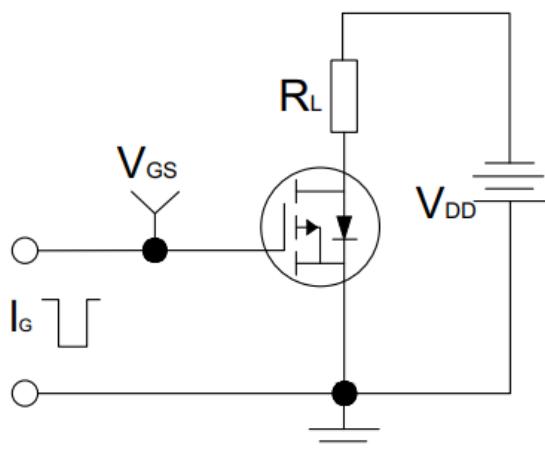
PMOS Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Test Conditions | Value | | | Unit |
|--|-----------------------------|--|-------|------|-----------|------------------|
| | | | Min. | Typ. | Max. | |
| Static Parameters | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$ | -60 | -- | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = -60\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 25^\circ\text{C}$ | -- | -- | -1 | μA |
| Gate-Source Leakage | I_{GSS} | $V_{\text{GS}} = \pm 20\text{V}$ | -- | -- | ± 100 | nA |
| Gate-Source Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$ | -1.2 | -1.7 | -2.2 | V |
| Drain-Source On-Resistance | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = -10\text{V}, I_D = -3.1\text{A}$ | -- | 62 | 80 | $\text{m}\Omega$ |
| | | $V_{\text{GS}} = -4.5\text{V}, I_D = -0.2\text{A}$ | -- | 72 | 95 | |
| Forward Transconductance | g_{FS} | $V_{\text{DS}} = -5\text{V}, I_D = -3.1\text{A}$ | -- | 6.6 | -- | S |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -30\text{V}, f = 1.0\text{MHz}$ | -- | 1454 | -- | pF |
| Output Capacitance | C_{oss} | | -- | 62 | -- | |
| Reverse Transfer Capacitance | C_{rss} | | -- | 58 | -- | |
| Total Gate Charge | Q_g | $V_{\text{DD}} = -30\text{V}, I_D = -3\text{A}, V_{\text{GS}} = -10\text{V}$ | -- | 37 | -- | nC |
| Gate-Source Charge | Q_{gs} | | -- | 4.5 | -- | |
| Gate-Drain Charge | Q_{gd} | | -- | 10.5 | -- | |
| Turn-on Delay Time | $t_{\text{d}(\text{on})}$ | $V_{\text{DD}} = -30\text{V}, I_D = -3\text{A}, R_G = 3\Omega$ | -- | 8 | -- | ns |
| Turn-on Rise Time | t_r | | -- | 4 | -- | |
| Turn-off Delay Time | $t_{\text{d}(\text{off})}$ | | -- | 32 | -- | |
| Turn-off Fall Time | t_f | | -- | 7 | -- | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous Body Diode Current | I_S | $T_C = 25^\circ\text{C}$ | -- | -- | -3.1 | A |
| Body Diode Voltage | V_{SD} | $T_J = 25^\circ\text{C}, I_{\text{SD}} = -2\text{A}, V_{\text{GS}} = 0\text{V}$ | -- | -- | -1.2 | V |

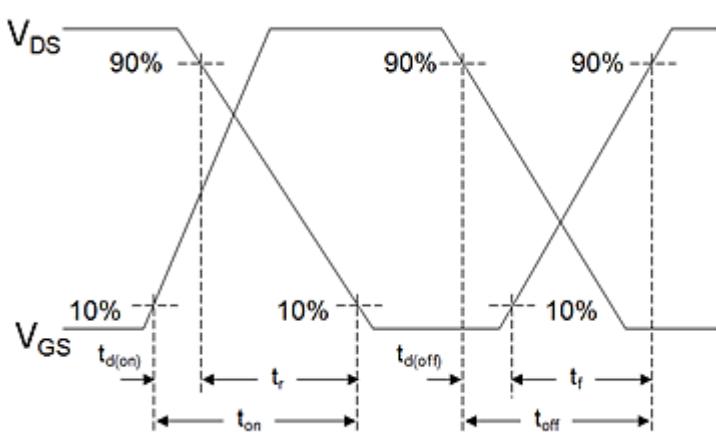
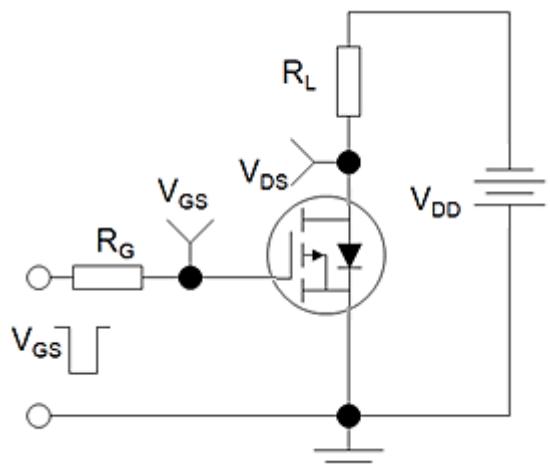
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

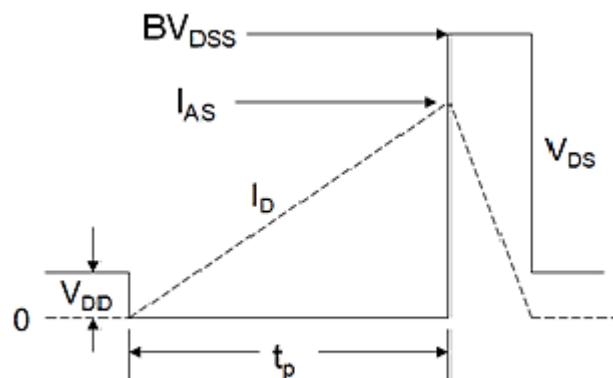
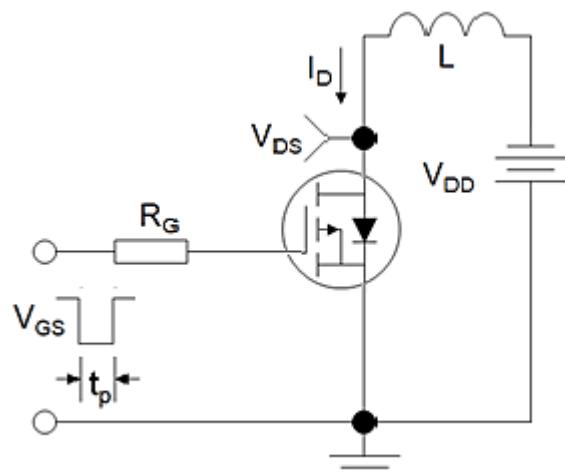
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



PMOS Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

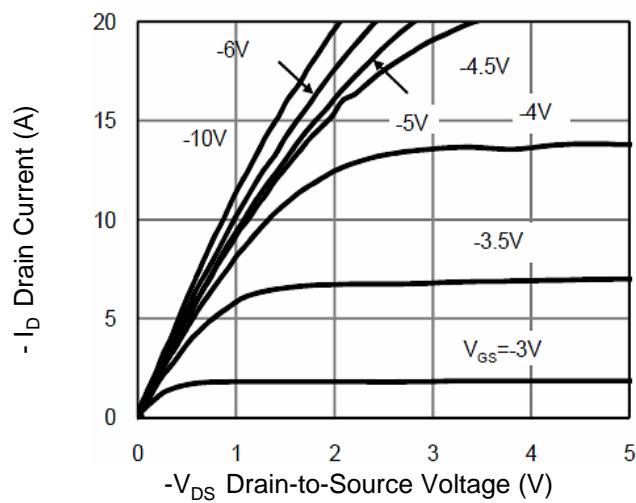


Figure 2. Transfer Characteristics

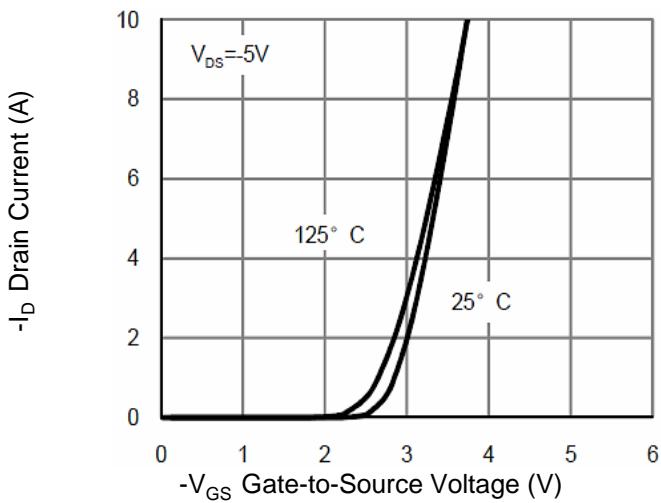


Figure 3.Rdson-Drain Current

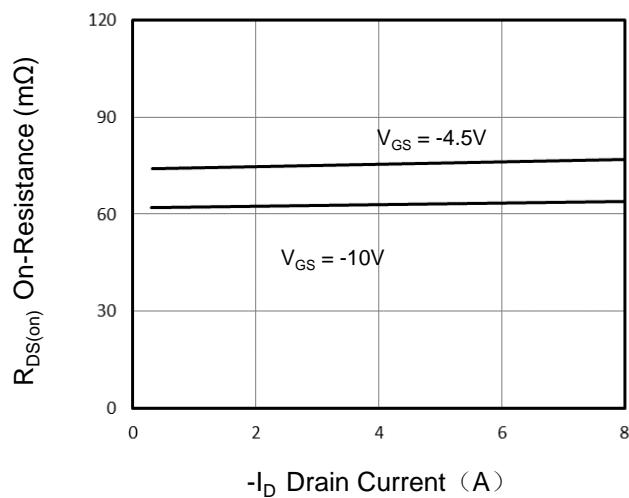


Figure 4. Gate Charge

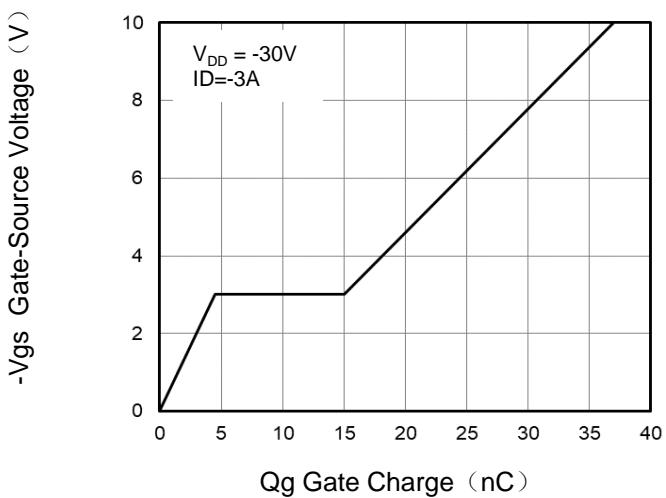


Figure 5. Capacitance

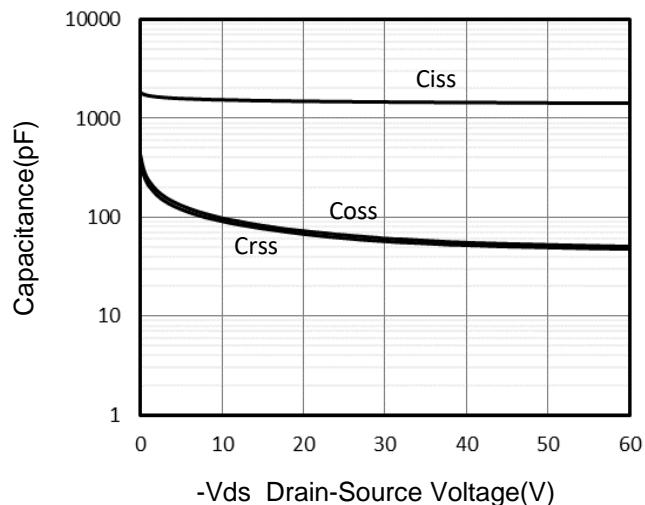
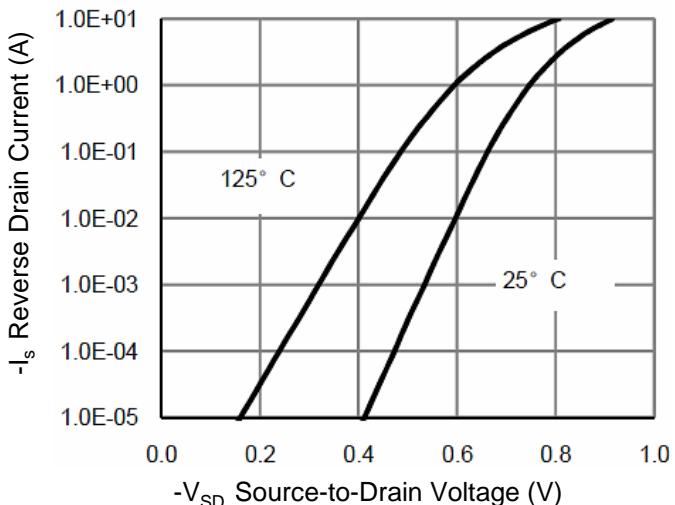


Figure 6. Source-Drain Diode Forward



PMOS Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

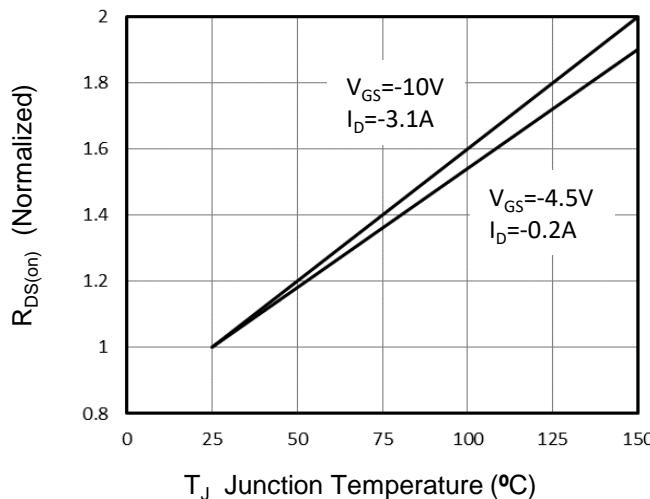


Figure 8. Safe Operation Area

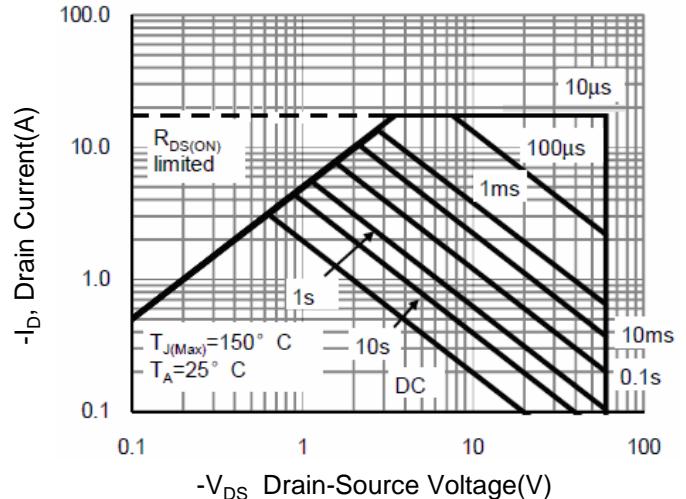
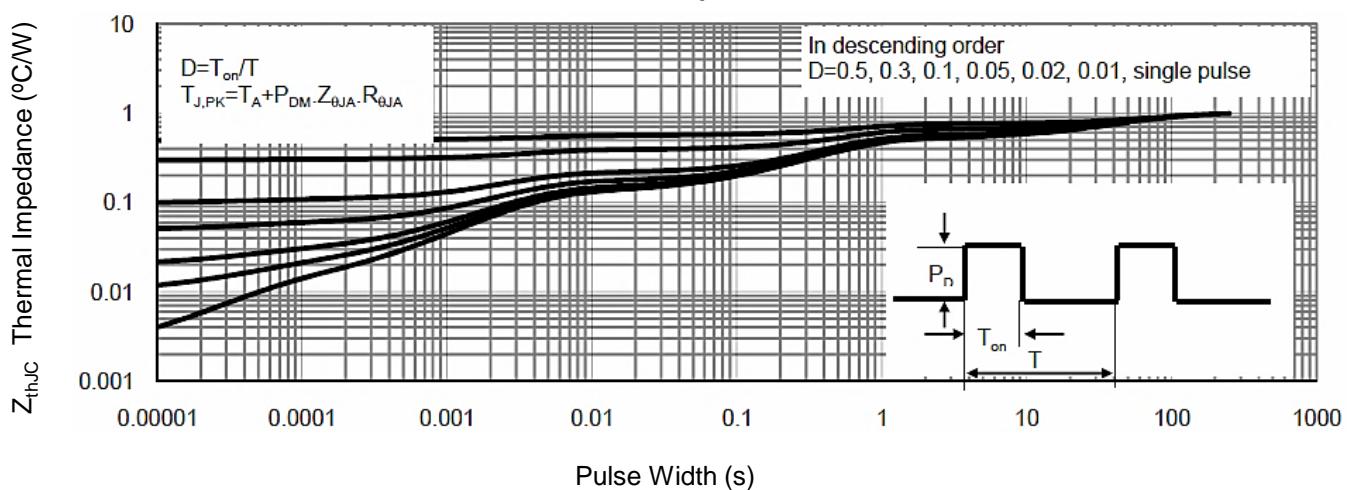
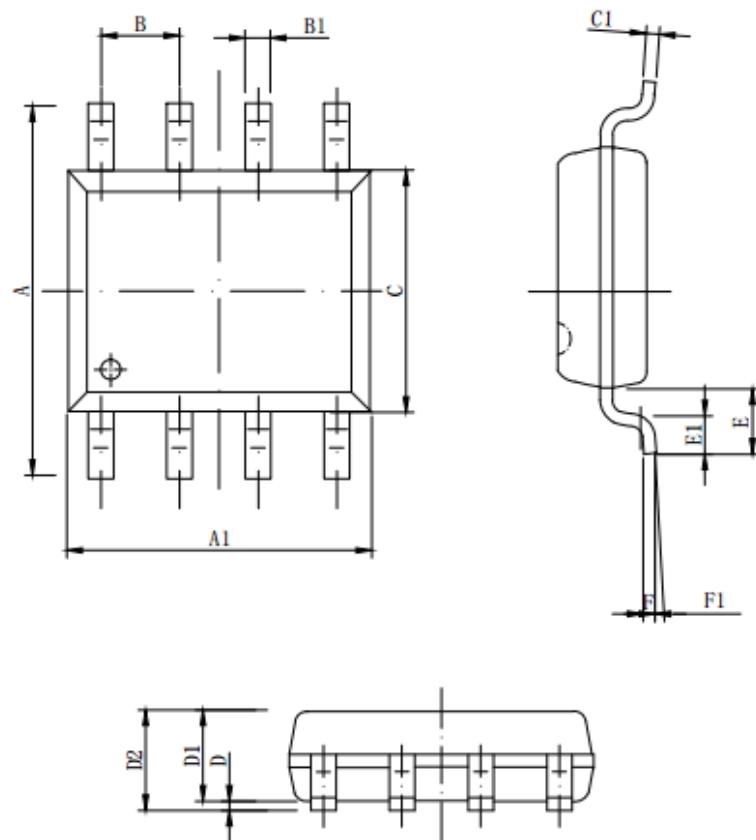


Figure 9. Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



| Symbol | Dimensions in Millimeters | | |
|---------------|----------------------------------|-------------|-------------|
| | MIN. | NOM. | MAX. |
| A | 5.800 | 6.000 | 6.200 |
| A1 | 4.800 | 4.900 | 5.000 |
| B | 1.270BSC | | |
| B1 | 0.35^8x | 0.40^8x | 0.45^8x |
| C | 3.780 | 3.880 | 3.980 |
| C1 | -- | 0.203 | 0.253 |
| D | 0.050 | 0.150 | 0.250 |
| D1 | 1.350 | 1.450 | 1.550 |
| D2 | 1.500 | 1.600 | 1.700 |
| D2 | 1.500 | 1.600 | 1.700 |
| E | 1.060REF | | |
| E1 | 0.400 | 0.700 | 0.100 |
| F | 0.250BSC | | |
| F1 | 2° | 4° | 6° |

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